Datasheet

Ver. 1.0



Revision History

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1. Overview

The SFM modules are stand-alone fingerprint systems ideal for embedded system applications where biometric security is needed. The modules are designed for manufacturers searching for an inexpensive, reliable and easy-to-integrate biometric system. The SFM modules provide complete fingerprint solutions by incorporating fingerprint sensor interface and embedded fingerprint recognition algorithm into a half business card sized module.

The SFM3000 series is the latest SFM module equipped with world's leading fingerprint authentication algorithm (ranked No. 1 in FVC2004 and FVC2006) and powerful DSP technology. Also, it supports wide range of fingerprint sensor interoperability giving you a freedom to select suitable sensor that most fits to your application. Furthermore, the fingerprint data for enrollment and verification are compatible among different sensors, even if they are based on different technologies. This feature of unification presents application manufacturers and system integrators with much more flexibility than ever before.

In addition to these features, the miniature sized SFM module has a state-of-the-art low power design making it a perfect match in a wide range of applications from battery operated mobile equipments to network based security systems. The SFM modules stand ready to meet your requirements and adapt to your applications.

2. SFM3000 Series

The SFM3000 series is the latest SFM module equipped with world's leading fingerprint authentication algorithm, which ranked No. 1 in FVC2004 and FVC2006. The SFM3000 series is based on powerful DSP technology, optimized for performance while minimizing power consumptions.

Table 1 summarizes available combinations of modules and sensors.

Table 1 SFM3000 Series combinations

Model name	Model name Supported sensors	
SFM3010-FC	Atmel Fingerchip	SFM3010
SFM3020-OP	Optical sensor I	SFM3020
SFM3030-OC/OD	SFM3030-OC/OD Optical sensor II	
SFM3040-OL Optical sensor III		SFM3040
SFM3050-TC1 UPEK TouchChip TCS1CD		SFM3050
SFM3050-TC2 UPEK TouchChip TCS2		

3. Features

- World best authentication performance (ranked No. 1 in FVC2004 and FVC2006)
- High speed fingerprint verification
- Compact size
- Low power consumption
- Fast power on time
- Supports various communication interfaces
- Supports fingerprint data encryption
- Supports various fingerprint sensors
- Highly configurable I/O signals
- Operates with a single 3.3v dc supply

4. Fingerprint Authentication Specifications

4.1. Fingerprint Authentication Performance

EER*	<0.1%
Enrollment time	<1 sec
Verification time	<1 sec

^{*}EER is dependent on databases

4.2. Fingerprint Sensor Specifications

Device Name	Optical sensor III
Sensor technology	Optical
Sensing area	15.5mm x 17.7mm
Image size(pixels)	256 x 288
Image resolution	500 dpi

5. Hardware Specifications

5.1. Operating range

Parameter	Symbol	Min	Тур	Max	Units
Supply voltage	V_{DD}	3.0	3.3	3.6	V
Operating temperature	T _{OP}	0		70	°C

5.2. Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Units
Power supply voltage	V_{DD}	-0.3	3.6	٧
Input voltage on signal pins	V_{IN}	-0.3	3.6	٧

5.3. Electrical DC characteristics($V_{DD} = 3.3 \text{Vdc}$, $T_{OP} = 25^{\circ}\text{C}$)

Parameter	Symbol	Min.	Тур.	Max.	Units
Supply current (idle)	I_{DD1}		67		mA
Supply current (scanning)	I_{DD2}		112		mA
Supply current (identifying)	I_{DD3}		188	210	mA

Parameter	Symbol	Min.	Тур.	Max.	Units
High level input voltage	V_{IH}	2.0		3.6	V
Low level input voltage	V_{IL}	-0.3		0.6	V

5.4. Interface

Туре	Description	
UART	3.3V CMOS level	
	Baud rates up to 921.6kbps (factory default is 115.2kbps)	
	RS232/422/485 supported via additional level converter	
Digital I/O	3.3V CMOS level	
	8 ports separately configurable	
	26bit Wiegand I/O supported via additional level converter	

5.5. Connector Specifications

Connector	Usage	
J1	Host interface port I	
J2	Host interface port II (Molex 53261-8090 compatible)	
J3	Debug port for factory use only	
J4	Sensor interface port, 20 pin FPC/FFC	

5.5.1. J1 pin assignment

Name	Pin number	Functions
VSS	4,14	Power Ground
VDD	9	Power pin. 3.3Vdc
GPIO_0 ~	5,6,7,8,1,2,3,	3.3V CMOS, bidirectional port
GPIO_7	15	
H_RXD	10	Receive Data, 5V tolerant 3.3V CMOS,
		input only
H_TXD	11	Transmit Data, 3.3V CMOS, output only
Reserved	12, 13	Reserved for future use

5.5.2. J2 pin assignment

Name	Pin number	Functions	
VDD	1,	Power pin. Must be connected to 3.3vdc	
Reserved	2, 3	Reserved for future use	
VSS	4,7	Power Ground	
H_RXD	5	Receive Data, 5V tolerant 3.3V CMOS,	
		input only	
H_TXD	6	Transmit Data, 3.3V CMOS, output only	
SHIELD	8	Ground Shield	

5.6. Physical Dimensions

Parameter	Values
Main board	55mm x 40mm x 8mm (WxLxH)
Sensor	20.5mm x 25mm x 52mm (WxLxH)

Figure 1 Main module dimensions

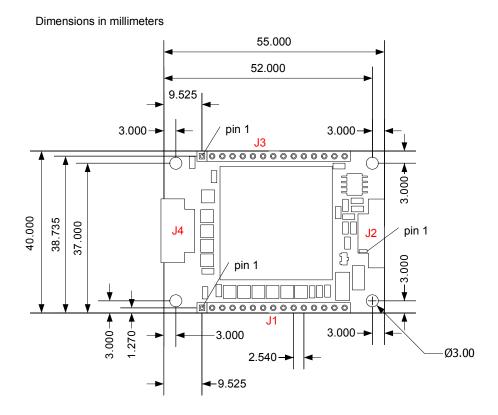
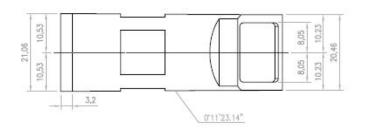
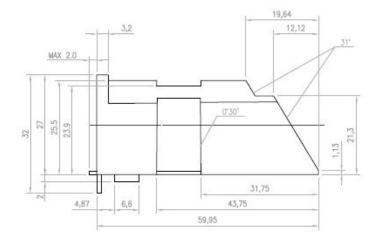
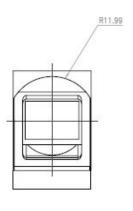
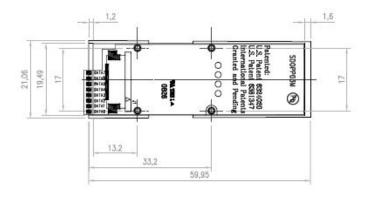


Figure 2 Sensor dimensions









Dimensions in millimeters

6. Communication Protocol Summary

The SFM modules provide a proprietary communication protocol for easy interface with most host systems. The protocol based on fixed sized packets. Only fingerprint image, template data, and user lists are transmitted as appended to the packet. Checksum functionality is supported to ensure consistency of transmitted data.

Please refer to SFM Protocol Manual for detailed information.

6.1. Packet Structure

Start code	Command	Param	Size	Flag	Checksum	End code
1byte	1byte	4bytes	4bytes	1byte	1byte	1byte

6.2. Command Summary

Command	Code	Description
SW	0x01	System parameter write
SF	0x02	System parameter save
SR	0x03	System parameter read
SS	0x04	System status check
ES	0x05	Enroll by scan
EI	0x06	Enroll by image
ET	0x07	Enroll by template
VS	0x08	Verify by scan
VI	0x09	Verify by image
VT	0x10	Verify by template
VH	0x22	Verify host template by scan
IS	0x11	Identify by scan
II	0x12	Identify by image
IT	0x13	Identify by template
RI	0x20	Read image
RT	0x14	Read template
SI	0x15	Scan image
ST	0x21	Scan template
DT	0x16	Delete template

Command	Code	Description
DA	0x17	Delete all templates
LT	0x18	List user ID
СТ	0x19	Check user ID
FP	0x23	Fix all provisional templates
DP	0x24	Delete all provisional templates
KW	0x34	Encryption key write
KS	0x35	Scan template with challenge data
GR	0x36	Read GPIO configuration
GW	0x37	Write GPIO configuration
GC	0x38	Clear GPIO configuration
GD	0x39	Set default GPIO configuration

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